

A VISION OF EXCELLENCE



Holo/Or is the world leader for Diffractive Optics

1989 1994 2020 2013 2017 2019 Steady growth in laser Continuous growth New POG Strategic partnership • Holo/Or First commercial with **TechInvest** established use of CO₂ usage begins showing leads to re-organization product line and enables wafer level diffraction limited affect on Holo/Or's **Holding Ag** (Scanlab) DOEs demand production DOE

- First to deliver DOEs for commercial use
- Break through technology
- Vast experience & expertise
- Diverse and extensive collection of beam shaping solutions

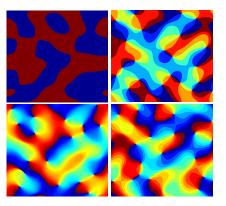






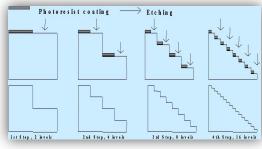
Holo/Or develops, designs and manufactures DOEs

- DOEs are thin diffractive windows that shape light
- Any desired intensity profile or shape
- In many applications DOEs significantly improve system performance
- DOEs advantages:
 - High (absolute) angle precision
 - High LDT
 - Thin & compact
 - Flexible shaping in single surface









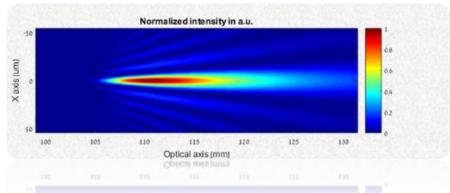


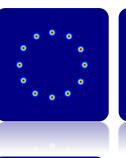


The power of Diffractive Optics

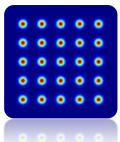
Main DOE families:

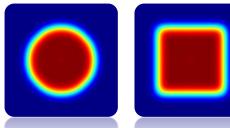
- Beam Splitters
- Beam Shapers
- Beam Foci (Focal shapers)

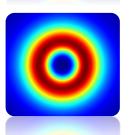










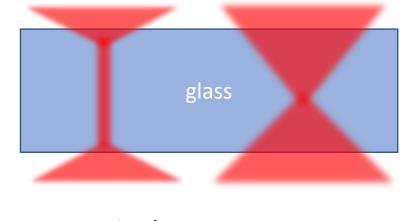




HoloOr EPIC challenges for laser optics 11.4.2021

Glass filamentation cutting using non-linear plasma process, main cut

- Typical characteristics:
 - ~1um wavelength
 - 10-40KHz rep rate
 - pulsed ps laser
 - μJ mJ power range
- 1-5µm tight focus is required to reach process threshold
- Depth of focus needs to be of the order of the glass thickness,
 typically 1-3mm
- Thus, DOF can be >1000 Rayleigh lengths



required focus for glass cutting

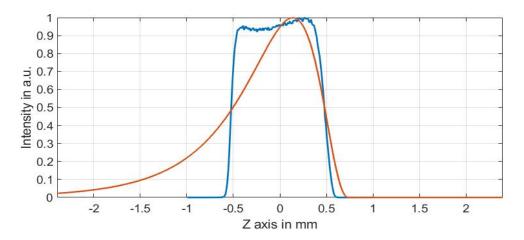
Gaussian beam focus

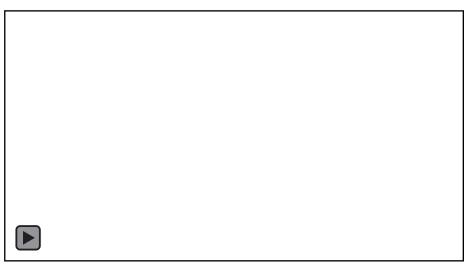


Solution through the DeepCleave Module

- <u>Input</u>: 6mm diameter single-mode laser beam
- Output: Tight spot with ~ 1.8 um waist size along the entire Depth of Focus (1-2mm typical range)
- Equivalent to NA =0.35 objective and is ideally suited for glass cutting of thick glasses, such as flat panels
- A complete optical solution for cutting applications
- No need for additional high NA objectives or other high cost optics









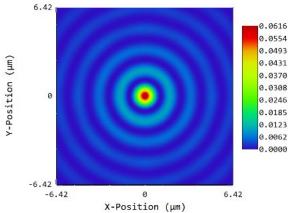
DeepCleave™ Glass cutting Module by Holo/Or Ltd.

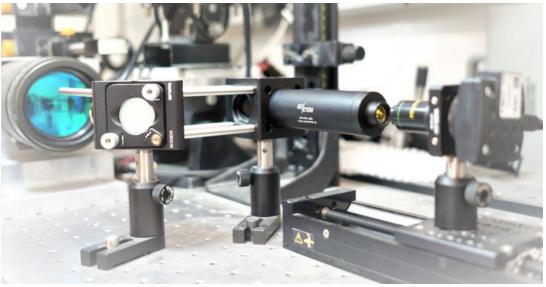
 Each Module is individually tested for performance using our custom built automatic setup

By adjusting beam size the Flat top slope in Z can

be changed

• Straightforward Installation & calibration procedure is provided in attached manual

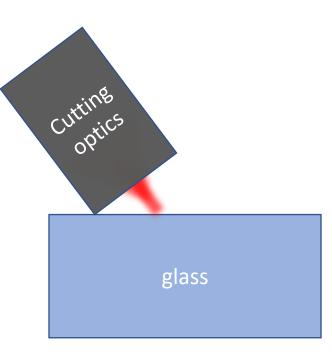






Laser glass cutting for edge bevel at 45 deg

- Typical cut:
 - 200-300μm long
 - 45 deg to optical axis
- Laser parameters are the same as for the main cut using filamentation method
- Tight focus similar to main cut
- Challenges with tilting the cut optics:
 - Complex path cutting requires continuous rotation of the optic
 - Cut optics (such as DeepCleave) has very short work distances
 and cannot be tilted to give 45 deg due to opto-mechanical limits



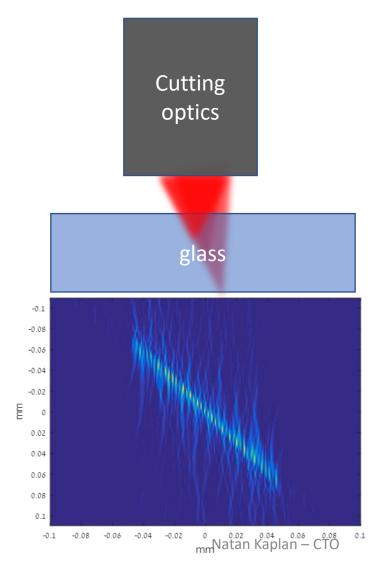


Solution through shifted multifocal element

- A single DOE+ focusing optics such as aspheric lens
- DOE generates multiple orders with shift in the x and Z direction
- Prevents need for rotating the cutting optics, only the DOE
- Has good depth of focus and work distance (~20mm typically),
 comes vertically to the glass surface
- Can be added as post processing step after main cut

 Holo/Or is developing a less speckled solution, with smoother intensity distribution.





Thank you!

Feel Free To Ask Questions

For more detailed follow-up, contact us at : holoor@holoor.co.il



